

CM1205

8-Channel ESD Protection Array in Chip Scale Package

Description

The CM1205 transient voltage suppressor array provides a very high level of protection for sensitive electronic components that may be subjected to ESD.

The CM1205 will safely dissipate ESD strikes at levels well beyond the maximum requirements set forth in the IEC 61000-4-2 international standard (Level 4, ± 8 kV contact discharge). All I/Os are rated at ± 25 kV using the IEC 61000-4-2 contact discharge method. Using the MIL-STD-883D (Method 3015) specification for Human Body Model (HBM) ESD, all pins are protected for contact discharges to greater than ± 30 kV.

The Chip Scale Package format of this device enables extremely small footprints that are necessary in portable electronics such as cellular phones, PDAs, internet appliances and PCs. The large solder bumps allow for standard attachment to laminate boards without the use of underfill.

The CM1205 features *OptiGuard*[™] coating for improved reliability at assembly and is available with RoHS compliant lead-free finishing.

Features

- Functionally and Pin Compatible with ON Semiconductor's PACDN1408 ESD Protection Device
- 8 Transient Voltage Suppressors in a Single Package
- Optiguard[™] Coated for Improved Reliability at Assembly
- In-system Electrostatic Discharge (ESD) Protection to ± 25 kV Contact Discharge per IEC 61000-4-2 International Standard
- Compact Chip Scale Package (0.65 mm pitch) Format Saves Board Space and Eases Layout in Space Critical Applications Compared to Discrete Solutions and Traditional Wire Bonded Packages
- 10-bump CSP
- These Devices are Pb-Free and are RoHS Compliant

Applications

- ESD Protection for Sensitive Electronic Equipment
- I/O Port, Keypad and Button Circuitry Protection for Portable Devices
- Wireless Handsets
- Handheld PCs / PDAs
- MP3 Players
- Digital Cameras and Camcorders
- Notebooks
- Desktop PCs



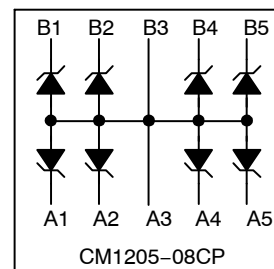
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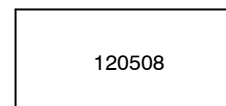


WLCSP10
CP SUFFIX
CASE 567BM

BLOCK DIAGRAM



MARKING DIAGRAM



120508 = Specific Device Code

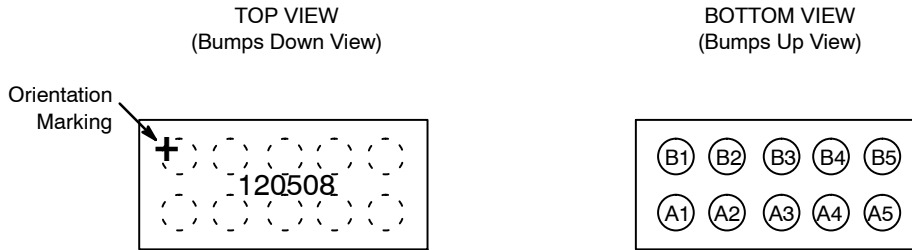
ORDERING INFORMATION

Device	Package	Shipping [†]
CM1205-08CP	CSP (Pb-Free)	3500/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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PACKAGE / PINOUT DIAGRAMS



CM1205-08
10-bump CSP Package

SPECIFICATIONS

Table 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 2. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Sym- bol	Parameter	Conditions	Min	Typ	Max	Units
V _{REV}	Reverse Standoff Voltage	I _{DIODE} = 10 μA		6.0		V
I _{LEAK}	Leakage Current	V _{IN} = 3.3 V DC			100	nA
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10mA	5.6 -1.2	6.8 -0.8	8.0 -0.4	V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	Note 2	±30 ±25			kV
V _{CL}	Clamping Voltage during ESD Discharge MIL-STD-883 (Method 3015), 8 kV Positive Transients Negative Transients	Note 2		+12 -8		V
C	Channel Capacitance	At 2.5 V DC, f = 1 MHz		39	47	pF

- T_A = 25 °C unless otherwise specified. GND in this document refers to the lower supply voltage.
- ESD applied to channel pins with respect to GND, one at a time. All other channels are open. All GND pins tied to ground.

APPLICATION INFORMATION

Refer to Application Note "The Chip Scale Package", for a detailed description of Chip Scale Packages offered by ON Semiconductor.

Table 4. PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	Value
Pad Size on PCB	0.275 mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.350 mm Round
Solder Stencil Thickness	0.125 – 0.150 mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.330 mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance – Edge To Corner Ball	±50 µm
Solder Ball Side Coplanarity	±20 µm
Maximum Dwell Time Above Liquidous	60 seconds
Maximum Soldering Temperature	260°C

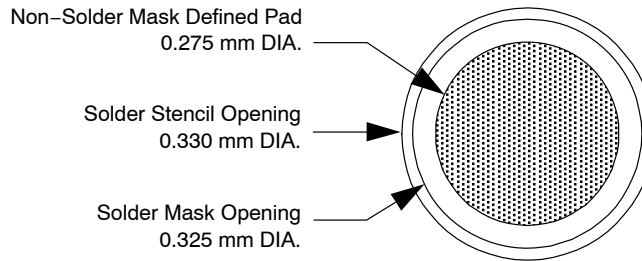


Figure 1. Recommended Non-Solder Mask Defined Pad Illustration

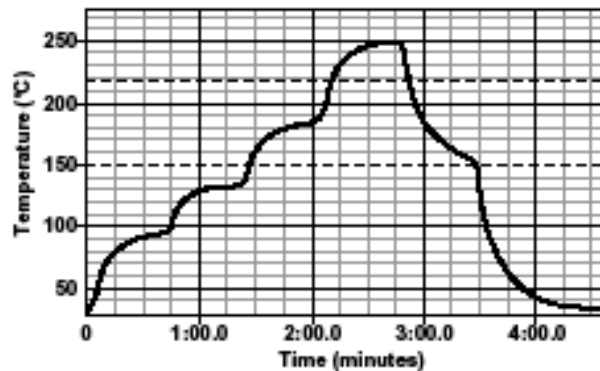


Figure 2. Lead-free (SnAgCu) Solder Ball Reflow Profile

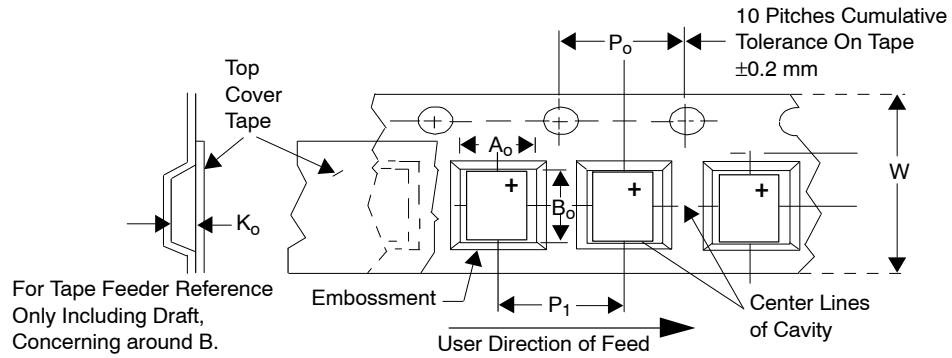
CM1205

MECHANICAL SPECIFICATIONS

The CM1205-08CP is offered in a 10-bump custom Chip Scale Package (CSP). Dimensions are presented below.

Table 5. CSP TAPE AND REEL SPECIFICATIONS

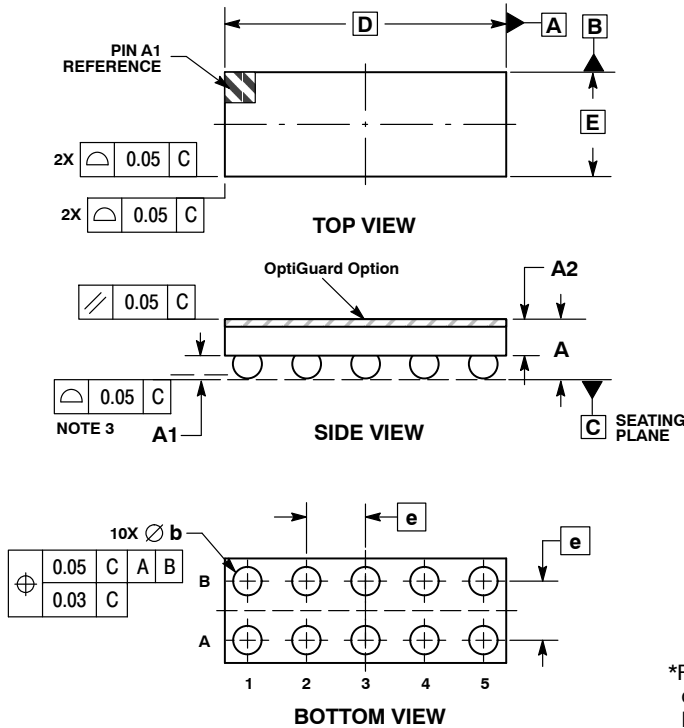
Part Number	Chip Size (mm)	Pocket Size (mm) $B_0 \times A_0 \times K_0$	Tape Width W	Reel Diameter	Qty per Reel	P_0	P_1
CM1205-08CP	3.104 X 1.154 X 0.682	3.28 X 1.32 X 0.81	8 mm	178 mm (7")	3500	4 mm	4 mm



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PACKAGE DIMENSIONS

WLCSP10, 3.10x1.15
CASE 567BM-01
ISSUE O

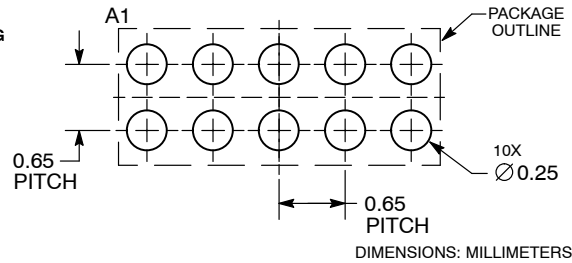


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.60	0.75
A1	0.23	0.29
A2	0.40 REF	
b	0.34	0.39
D	3.10 BSC	
E	1.15 BSC	
e	0.65 BSC	

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А